

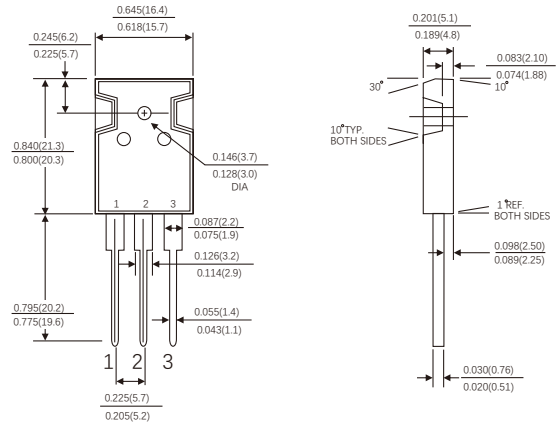
DESCRIPTION

SiC Schottky Diode has no switching loss, provides improved system efficiency against Si diodes by utilizing new semiconductor material-Silicon Carbide, enables higher operating frequency, and helps increasing power density and reduction of system size /cost. Its high reliability ensures robust operation during surge or over_voltage conditions.

FEATURES

- Max Junction Temperature 175°C
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery

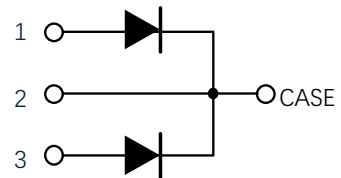
TO-247AB



Dimensions in inches and (millimeters)

MECHANICAL DATA

- Case: JEDEC TO-247AB
- Molding compound meets UL94V-0 flammability rating
- Terminals: Lead solderable per J-STD-002 and JESD22-B102
- Polarity: As marked
- Mounting Torque: 10 in-lbs maximum



TYPICAL APPLICATIONS

- General Purpose
- SMPS, Solar inverter, UPS
- Power Switching Circuits

KEY PERFORMANCE AND PACKAGE PARAMETERS (leg/device)

Type	V _{DC}	I _F	Q _c	T _{j,max}	Package
SC20120PT	1200V	10A/20A	30nC/60nC	175°C	TO-247AB

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

Parameters	Symbol	Value	Unit
Maximum repetitive peak reverse voltage Per Leg	V_{RRM}	1200	V
Continuous forward current for $R_{th(j-c)}$ Per Leg	I_F	10 ($T_c = 156^\circ C$) 16 ($T_c = 133^\circ C$) 34 ($T_c = 25^\circ C$)	A
Non-repetitive forward surge current Per Leg (Haif-Sine Pulse, $t_p = 8.3ms$)	I_{FSM}	90 ($T_c = 25^\circ C$) 78 ($T_c = 150^\circ C$)	A
I^2t value Per Leg	I^2t	34 ($T_c = 25^\circ C$) 27 ($T_c = 150^\circ C$)	A ² S
Diode dv/dt ruggedness ($V_R = 0 \dots 960V$) Per Leg	dv/dt	80	V/nS
Power dissipation for $R_{th(j-c,max)}$ ($T_c = 25^\circ C$)	P_{tot}	150	W
Operating junction temperature range	T_j	-55...175	°C
Storage temperature range	T_{stg}	-55...175	°C

THERMAL CHARACTERISTICS (TA=25°C Unless otherwise noted)

Parameter	Symbol	Value (leg/device)		Unit
		Typ	Max	
Diode thermal resistance junction-case	$R_{th(j-c)}$	0.8/0.4		°C/W

ELECTRICAL CHARACTERISTICS (T_J=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Value(leg/device)			Unit
			min	typ	max	
DC blocking voltage	V _{dc}	T _J =25...175°C	1200			V
Diode forward voltage	V _F	I _F =10A/20A T _J =25°C I _F =10A/20A T _J =125°C I _F =10A/20A T _J =175°C		1.7 2.3 2.8	1.9 2.5 3.2	V
Reverse current	I _R	V _R =1200V T _J =25°C V _R =1200V T _J =125°C V _R =1200V T _J =175°C			20/40 100/200 200/400	μA

DYNAMIC CHARACTERISTICS(at T_J=25°C,unless otherwise specified)

Parameter	Symbol	conditions	Value(leg/device)			Unit
			min	typ	max	
Total capacitive charge	Q _c	V _R =1200V,I _F =10A di/dt=200A/μS T _J =25°C		30/60		nC
Total capacitance	C	V _R =1V,f=1MHz V _R =400V,f=1MHz V _R =800V,f=1MHz T _J =25°C		650/1300 49/98 40/80		pF

FIG.1-FORWARD CURRENT DERATING CURVE(device)

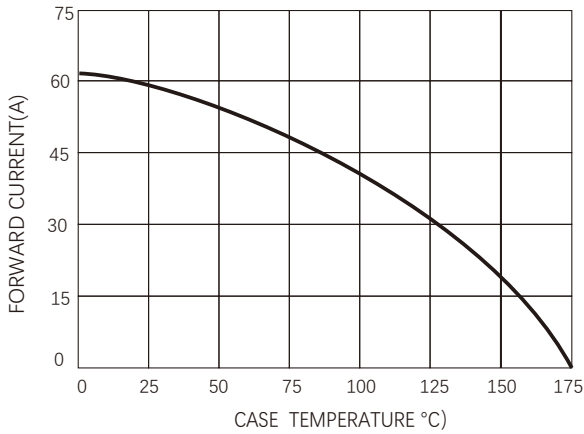


FIG.2-TYPICAL JUNCTION CAPACITANCE(per leg)

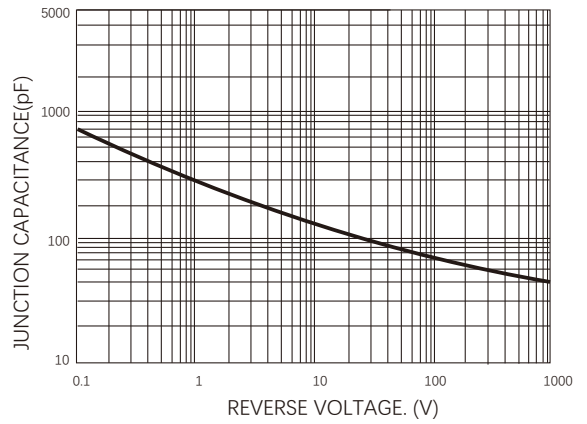


FIG.3-FORWARD CURRENT DERATING CURVE(per leg)

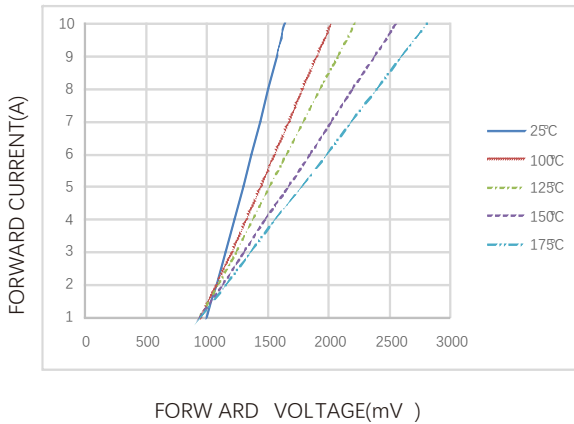
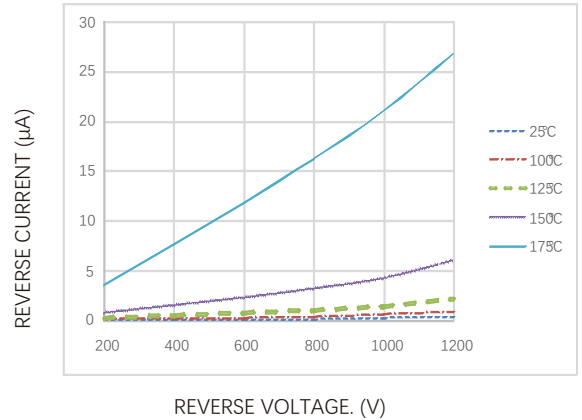


FIG.4-REVERSE CHARACTERISTICS(per leg)



Friendship Reminder

- JiNan JingHeng(hereinafter referred to as JH)reserves the right to make changes to this document and its products and specifications at anytime without notice.
- Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.
- JH makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does JH assume any liability for application assistance or customer product design.
- JH does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.
- No license is granted by implication or otherwise under any intellectual property rights of JH.
- JH's products are not authorized for use as critical components in life support devices or systems without express written approval of JH.